



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Kie Y. Ahn et al.

Title:

COPPER ELECTROLESS DEPOSITION TECHNOLOGY FOR ULSI METALIZATION

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Commissioner for Patents Washington, D.C. 20231

We are transmitting herewith the following attached items (as indicated with an "X"):

X

An Information Disclosure Statement (1 pg.), Form 1449 (5 pgs.), and copies of 101 cited references. A Communication Concerning Co-Pending Applications (2 pgs.).

Copies of Co-Pending Applications (6 copies.).

Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these pape please charge any additional required fees or credit overpayment to Deposit Account No. 19-0743.

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington,

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